# Ignition IGBT 18 Amps, 400 Volts

## **N–Channel D<sup>2</sup>PAK**

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over–Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

#### Features

- Ideal for Coil–on–Plug Applications
- Gate-Emitter ESD Protection
- Temperature Compensated Gate–Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- New Design Increases Unclamped Inductive Switching (UIS) Energy Per Area
- Low Threshold Voltage to Interface Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- Integrated Gate–Emitter Resistor (R<sub>GE</sub>)
- Emitter Ballasting for Short-Circuit Capability
- These are Pb–Free Devices

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

| Rating   | Symbol                            | Value       | Unit                               |
|--|-----------------------------------|-------------|------------------------------------|
| Collector-Emitter Voltage  | V <sub>CES</sub>                  | 430         | V <sub>DC</sub>                    |
| Collector–Gate Voltage   | V <sub>CER</sub>                  | 430         | V <sub>DC</sub>                    |
| Gate-Emitter Voltage   | $V_{GE}$                          | 18          | $V_{DC}$                           |
| Collector Current–Continuous<br>@ $T_C = 25^{\circ}C$ – Pulsed       | Ι <sub>C</sub>                    | 18<br>50    | A <sub>DC</sub><br>A <sub>AC</sub> |
| ESD (Human Body Model)<br>R = 1500 Ω, C = 100 pF                     | ESD                               | 8.0         | kV                                 |
| ESD (Machine Model) $R = 0 \Omega$ , $C = 200 pF$                    | ESD                               | 800         | V                                  |
| Total Power Dissipation @ T <sub>C</sub> = 25°C<br>Derate above 25°C | P <sub>D</sub>                    | 115<br>0.77 | W<br>W/∘C                          |
| Operating and Storage Temperature Range                              | T <sub>J</sub> , T <sub>stg</sub> | -55 to +175 | °C                                 |

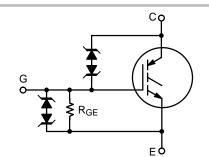
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



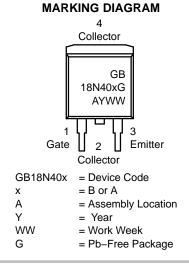
## **ON Semiconductor®**

www.onsemi.com

18 AMPS, 400 VOLTS V<sub>CE(on)</sub> ≤ 2.0 V @ I<sub>C</sub> = 10 A, V<sub>GE</sub> ≥ 4.5 V







#### ORDERING INFORMATION

| Device          | Package            | Shipping <sup>†</sup> |
|-----------------|--------------------|-----------------------|
| NGB18N40CLBT4G  | D <sup>2</sup> PAK | 800/Tape & Reel       |
| NGB18N40ACLBT4G | (Pb-Free)          |                       |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### UNCLAMPED COLLECTOR-TO-EMITTER AVALANCHE CHARACTERISTICS (-55° $\leq$ T<sub>J</sub> $\leq$ 175°C)

| Characteristic  | Symbol             | Value      | Unit |
|---|--------------------|------------|------|
| Single Pulse Collector–to–Emitter Avalanche Energy<br>$V_{CC} = 50 \text{ V}, \text{ V}_{GE} = 5.0 \text{ V}, \text{ Pk I}_L = 21.1 \text{ A}, \text{ L} = 1.8 \text{ mH}, \text{ Starting T}_J = 25^{\circ}\text{C}$<br>$V_{CC} = 50 \text{ V}, \text{ V}_{GE} = 5.0 \text{ V}, \text{ Pk I}_L = 18.3 \text{ A}, \text{ L} = 1.8 \text{ mH}, \text{ Starting T}_J = 125^{\circ}\text{C}$ | E <sub>AS</sub>    | 400<br>300 | mJ   |
| Reverse Avalanche Energy V <sub>CC</sub> = 100 V, V <sub>GE</sub> = 20 V, Pk I <sub>L</sub> = 25.8 A, L = 6.0 mH, Starting T <sub>J</sub> = 25°C  | E <sub>AS(R)</sub> | 2000       | mJ   |

### MAXIMUM SHORT–CIRCUIT TIMES (–55°C $\leq$ T $_{J}$ $\leq$ 150°C)

| Characteristic   | Symbol           | Value | Unit |
|--|------------------|-------|------|
| Short Circuit Withstand Time 1 (See Figure 17, 3 Pulses with 10 ms Period) | t <sub>sc1</sub> | 750   | μs   |
| Short Circuit Withstand Time 2 (See Figure 18, 3 Pulses with 10 ms Period) | t <sub>sc2</sub> | 5.0   | ms   |

#### THERMAL CHARACTERISTICS

| Characteristic  | Symbol                | Value | Unit |
|---|-----------------------|-------|------|
| Thermal Resistance, Junction-to-Case  | $R_{	extsf{	heta}JC}$ | 1.3   | °C/W |
| Thermal Resistance, Junction-to-Ambient D <sup>2</sup> PAK (Note 1)           | $R_{\thetaJA}$        | 50    | °C/W |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds | ΤL                    | 275   | °C   |

## **ELECTRICAL CHARACTERISTICS**

| Characteristic                            | Symbol               | Test Conditions                                   | Temperature                            | Min | Тур | Max      | Unit |
|---|----------------------|---|--|-----|-----|----------|------|
| OFF CHARACTERISTICS                       |                      |   |  |     |     |          |      |
| Collector-Emitter Clamp Voltage           | BV <sub>CES</sub>    | I <sub>C</sub> = 2.0 mA                           | $T_J = -40^{\circ}C$ to $150^{\circ}C$ | 380 | 395 | 420      | V    |
|   |                      | I <sub>C</sub> = 10 mA                            | $T_J = -40^{\circ}C$ to $150^{\circ}C$ | 390 | 405 | 430      |      |
| Zero Gate Voltage Collector Current       | I <sub>CES</sub>     |   | T <sub>J</sub> = 25°C                  | -   | 2.0 | 20       | μΑ   |
|   |                      | V <sub>CE</sub> = 350 V,<br>V <sub>GE</sub> = 0 V | T <sub>J</sub> = 150°C                 | -   | 10  | 40*      |      |
|   |                      | ·GE ···   | $T_J = -40^{\circ}C$                   | -   | 1.0 | 10       |      |
| Reverse Collector-Emitter Leakage Current | I <sub>ECS</sub>     |   | T <sub>J</sub> = 25°C                  | -   | 0.7 | 2.0      | mA   |
|   |                      | $V_{CE} = -24 V$                                  | T <sub>J</sub> = 150°C                 | -   | 12  | 25*      |      |
|   |                      |   | $T_J = -40^{\circ}C$                   | -   | 0.1 | 1.0      |      |
| Reverse Collector-Emitter Clamp Voltage   | B <sub>VCES(R)</sub> |   | $T_J = 25^{\circ}C$                    | 27  | 33  | 37       | V    |
|   |                      | I <sub>C</sub> = -75 mA                           | T <sub>J</sub> = 150°C                 | 30  | 36  | 40       |      |
|   |                      |   | $T_J = -40^{\circ}C$                   | 25  | 32  | 35       |      |
| Gate-Emitter Clamp Voltage                | BV <sub>GES</sub>    | l <sub>G</sub> = 5.0 mA                           | $T_J = -40^{\circ}C$ to $150^{\circ}C$ | 11  | 13  | 15       | V    |
| Gate-Emitter Leakage Current              | I <sub>GES</sub>     | V <sub>GE</sub> = 10 V                            | $T_J = -40^{\circ}C$ to $150^{\circ}C$ | 384 | 640 | 100<br>0 | μΑ   |
| Gate Emitter Resistor                     | R <sub>GE</sub>      | _   | $T_J = -40^{\circ}C$ to $150^{\circ}C$ | 10  | 16  | 26       | kΩ   |

**ON CHARACTERISTICS** (Note 2)

| Gate Threshold Voltage                       | V <sub>GE(th)</sub> |   | $T_J = 25^{\circ}C$  | 1.1  | 1.4 | 1.9  | V     |
|--|---------------------|---|----------------------|------|-----|------|-------|
|  |                     | I <sub>C</sub> = 1.0 mA,<br>V <sub>GE</sub> = V <sub>CE</sub> | $T_J = 150^{\circ}C$ | 0.75 | 1.0 | 1.4  |       |
|  |                     |   | $T_J = -40^{\circ}C$ | 1.2  | 1.6 | 2.1* |       |
| Threshold Temperature Coefficient (Negative) | -                   | _   | _                    | -    | 3.4 | -    | mV/°C |

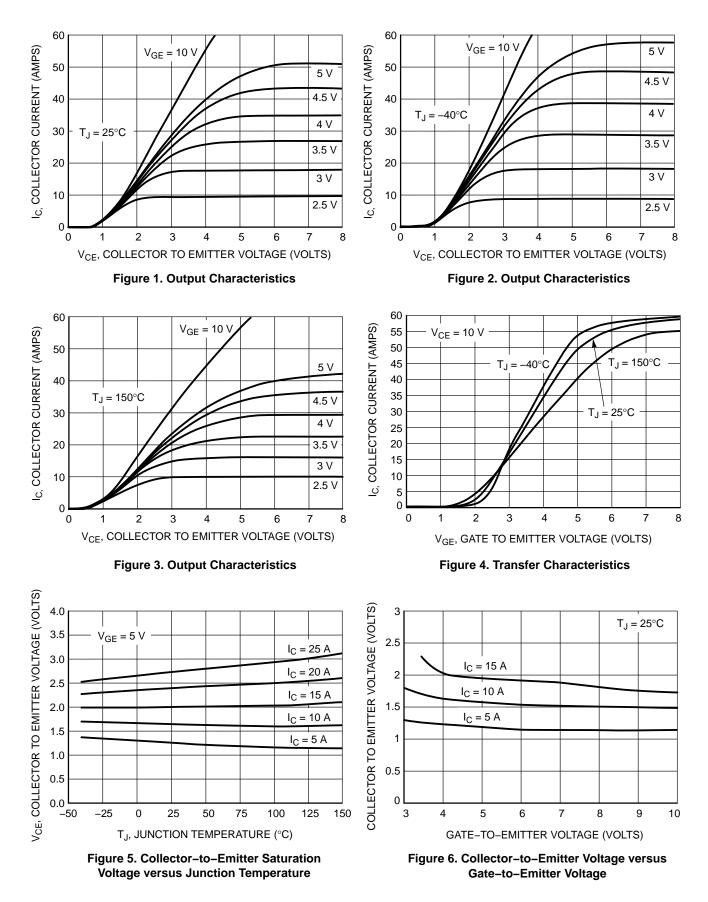
\*Maximum Value of Characteristic across Temperature Range. 1. When surface mounted to an FR4 board using the minimum recommended pad size. 2. Pulse Test: Pulse Width  $\leq$  300 µS, Duty Cycle  $\leq$  2%.

#### **ELECTRICAL CHARACTERISTICS**

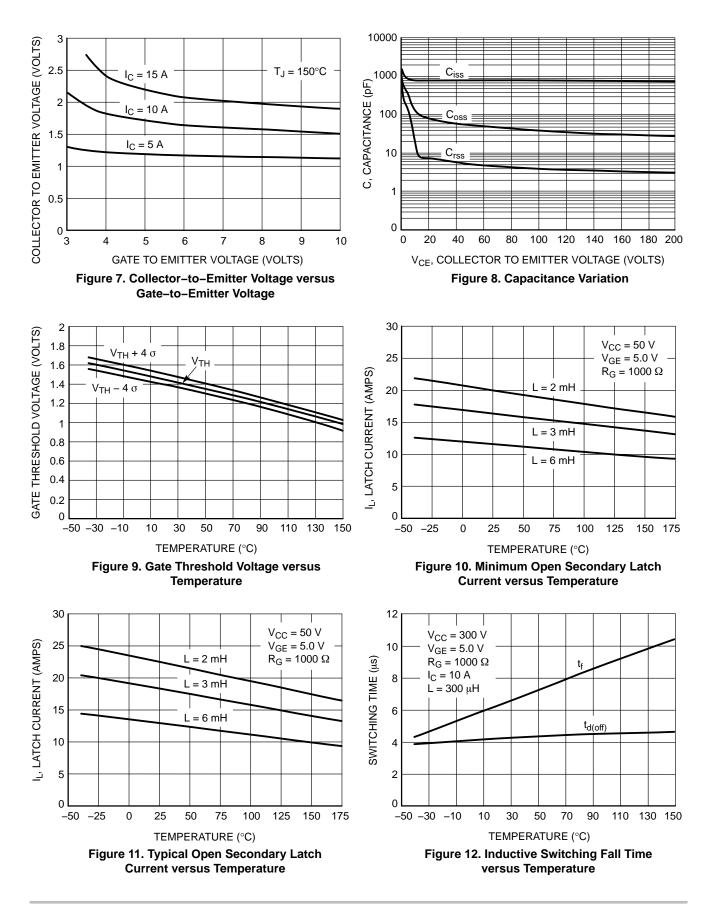
| Characteristic                  | Symbol              | Test Conditions  | Temperature                            | Min | Тур  | Max      | Unit |
|---------------------------------|---------------------|--|--|-----|------|----------|------|
| ON CHARACTERISTICS (Note 2)     |                     |  |  |     |      |          | -    |
| Collector-to-Emitter On-Voltage | V <sub>CE(on)</sub> |  | $T_J = 25^{\circ}C$                    | 1.0 | 1.4  | 1.6      | V    |
|                                 |                     | I <sub>C</sub> = 6.0 A,<br>V <sub>GE</sub> = 4.0 V   | T <sub>J</sub> = 150°C                 | 0.9 | 1.3  | 1.6      |      |
|                                 |                     | VGE - 4.0 V  | $T_J = -40^{\circ}C$                   | 1.1 | 1.45 | 1.7*     |      |
|                                 |                     |  | T <sub>J</sub> = 25°C                  | 1.3 | 1.6  | 1.9*     |      |
|                                 |                     | I <sub>C</sub> = 8.0 A,<br>V <sub>GE</sub> = 4.0 V   | T <sub>J</sub> = 150°C                 | 1.2 | 1.55 | 1.8      | 1    |
|                                 |                     | ige not  | $T_J = -40^{\circ}C$                   | 1.4 | 1.6  | 1.9*     |      |
|                                 |                     |  | T <sub>J</sub> = 25°C                  | 1.4 | 1.8  | 2.05     |      |
|                                 |                     | I <sub>C</sub> = 10 A,<br>V <sub>GE</sub> = 4.0 V  | T <sub>J</sub> = 150°C                 | 1.5 | 1.8  | 2.0      |      |
|                                 |                     | VGE - 1.0 V  | $T_J = -40^{\circ}C$                   | 1.4 | 1.8  | 2.1*     |      |
|                                 |                     |  | T <sub>J</sub> = 25°C                  | 1.6 | 1.9  | 2.2      |      |
|                                 |                     | I <sub>C</sub> = 15 A,<br>V <sub>GE</sub> = 4.0 V  | T <sub>J</sub> = 150°C                 | 1.7 | 2.1  | 2.3*     |      |
|                                 |                     | VGE - 1.0 V  | $T_{\rm J} = -40^{\circ}{\rm C}$       | 1.6 | 1.8  | 2.2      | 1    |
|                                 |                     |  | T <sub>J</sub> = 25°C                  | 1.3 | 1.8  | 2.0*     |      |
|                                 |                     | I <sub>C</sub> = 10 A,<br>V <sub>GE</sub> = 4.5 V  | T <sub>J</sub> = 150°C                 | 1.3 | 1.75 | 2.0*     |      |
|                                 |                     | VGE - 1.0 V  | $T_J = -40^{\circ}C$                   | 1.4 | 1.8  | 2.0*     |      |
| Forward Transconductance        | gfs                 | $V_{CE} = 5.0 \text{ V}, I_{C} = 6.0 \text{ A}$  | $T_J = -40^{\circ}C$ to $150^{\circ}C$ | 8.0 | 14   | 25       | Mhos |
| DYNAMIC CHARACTERISTICS         | •                   |  |  |     |      |          |      |
| Input Capacitance               | C <sub>ISS</sub>    | V <sub>CC</sub> = 25 V, V <sub>GE</sub> = 0 V  | $T_J = -40^{\circ}C$ to $150^{\circ}C$ | 400 | 800  | 100<br>0 | pF   |
| Output Capacitance              | C <sub>OSS</sub>    | f = 1.0  MHz   |  | 50  | 75   | 100      |      |
| Transfer Capacitance            | C <sub>RSS</sub>    |  |  | 4.0 | 7.0  | 10       |      |
| SWITCHING CHARACTERISTICS       | •                   | •  |  |     | •    |          |      |
| Turn-Off Delay Time (Resistive) | t <sub>d(off)</sub> |  | $T_J = 25^{\circ}C$                    | -   | 4.0  | 10       | μS   |
| Fall Time (Resistive)           | t <sub>f</sub>      | $V_{CC} = 300 \text{ V}, \text{ I}_{C} = 6.5 \text{ A}$<br>$R_{G} = 1.0 \text{ k}\Omega, \text{ R}_{L} = 46 \Omega,$     | $T_J = 25^{\circ}C$                    | -   | 9.0  | 15       |      |
| Turn-On Delay Time              | t <sub>d(on)</sub>  | $\begin{array}{l} V_{CC} = 10 \; V, \; I_{C} = 6.5 \; A \\ R_{G} = 1.0 \; k\Omega, \; R_{L} = 1.5 \; \Omega \end{array}$ | $T_J = 25^{\circ}C$                    | -   | 0.7  | 4.0      | μS   |
| Rise Time                       | t <sub>r</sub>      | $V_{CC}$ = 10 V, I <sub>C</sub> = 6.5 A<br>R <sub>G</sub> = 1.0 kΩ, R <sub>L</sub> = 1.5 Ω                               | T <sub>J</sub> = 25°C                  | -   | 4.5  | 7.0      |      |

\*Maximum Value of Characteristic across Temperature Range. 1. When surface mounted to an FR4 board using the minimum recommended pad size. 2. Pulse Test: Pulse Width  $\leq$  300 µS, Duty Cycle  $\leq$  2%.

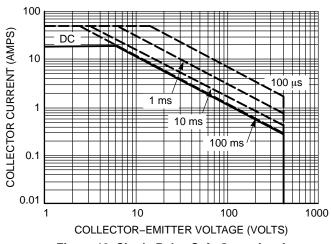
## **TYPICAL ELECTRICAL CHARACTERISTICS**

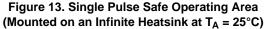


## **TYPICAL ELECTRICAL CHARACTERISTICS**



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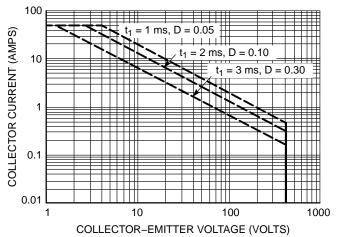
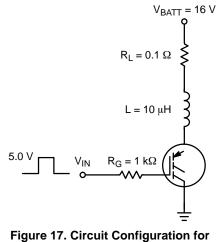


Figure 15. Pulse Train Safe Operating Area (Mounted on an Infinite Heatsink at  $T_c = 25^{\circ}C$ )



Short Circuit Test #1

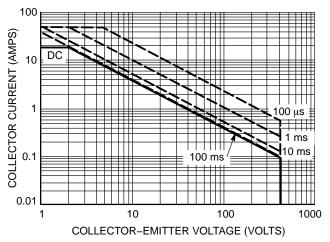


Figure 14. Single Pulse Safe Operating Area (Mounted on an Infinite Heatsink at  $T_A = 125^{\circ}C$ )

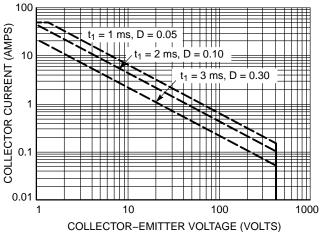


Figure 16. Pulse Train Safe Operating Area

(Mounted on an Infinite Heatsink at  $T_C = 125^{\circ}C$ )

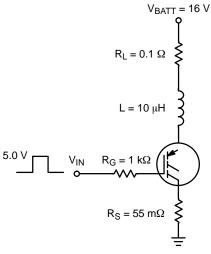


Figure 18. Circuit Configuration for Short Circuit Test #2

## **TYPICAL ELECTRICAL CHARACTERISTICS**

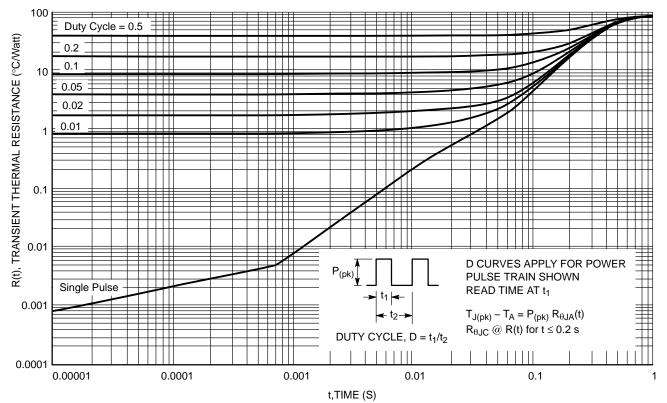
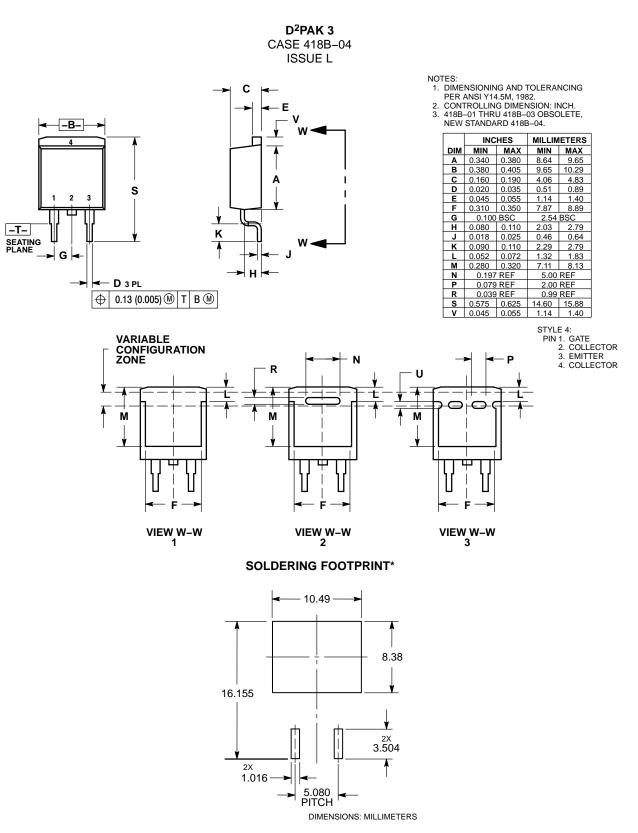


Figure 19. Transient Thermal Resistance (Non-normalized Junction-to-Ambient mounted on minimum pad area)

#### PACKAGE DIMENSIONS



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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